

Micro-Grain Copper Anode

Under the scientific production process of MPCA technology, Micro-Grain copper anode shows outstanding performance in plating application. It has the perfect surface and the best grain structure with extreme uniform distribution of phosphorus. Comparing normal copper anode, Micro-Grain copper anode ensures superior product quality and less overall production costs in the consideration of user's long term benefits.



Production process

Melting => MPCA Tech => Cold Heading => Polish & Clean => Packing

Elements Content						
Cu (%)	Phosphor (%)	Fe (%)	Pb (%)	Ni (%)	Zn (%)	Sn (%)
≥99.93	0.025 ~ 0.055	≤0.003	≤0.003	≤0.003	≤0.003	≤0.003

Product	Appearance	Packaging
Micro-Grain Copper Anode	ø25mm, ø28mm, ø33mm, ø40mm, ø 45mm, ø51mm, ø55mm	- Box : 25 Kg/Box - Pail: 50 Kg/Pail